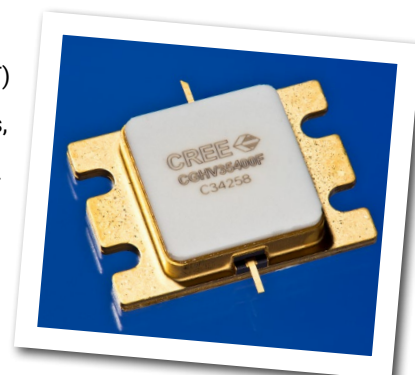


# CGHV35400F

**400 W, 2900 - 3500 MHz, 50-Ohm Input/Output Matched, GaN HEMT for S-Band Radar Systems**

Cree's CGHV35400F is a gallium nitride (GaN) high electron mobility transistor (HEMT) designed specifically with high efficiency, high gain and wide bandwidth capabilities, which makes the CGHV35400F ideal for 2.9 - 3.5 GHz S-Band radar amplifier applications. The transistor is matched to 50-ohms on the input and 50-ohms on the output. The CGHV35400 is based on Cree's high power density 50 V, 0.4  $\mu\text{m}$  GaN on silicon carbide (SiC) foundry process. The transistor is supplied in a ceramic/metal flange package, type 440217.



PN: CGHV35400F  
Package Type: 440225

## Typical Performance Over 2.9-3.5 GHz ( $T_c = 25^\circ\text{C}$ ) of Demonstration Amplifier

| Parameter        | 2.9 GHz | 3.2 GHz | 3.5 GHz | Units |
|------------------|---------|---------|---------|-------|
| Output Power     | 500     | 535     | 480     | W     |
| Gain             | 11.0    | 11.3    | 10.8    | dB    |
| Drain Efficiency | 74      | 69      | 64      | %     |

Note:

Measured in the CGHV35400F-AMP application circuit, under 500  $\mu\text{s}$  pulse width, 10% duty cycle,  $P_{IN} = 46 \text{ dBm}$ .

## Features

- 2.9 - 3.5 GHz Operation
- 500 W Typical Output Power
- 11 dB Power Gain
- 70% Typical Drain Efficiency
- 50 Ohm Internally Matched
- <0.3 dB Pulsed Amplitude Droop

Large Signal Models Available for ADS and MWO

## Absolute Maximum Ratings (not simultaneous)

| Parameter                                   | Symbol            | Rating    | Units | Conditions                                     |
|---------------------------------------------|-------------------|-----------|-------|------------------------------------------------|
| Pulse Width                                 | PW                | 500       | μs    |                                                |
| Duty Cycle                                  | DC                | 10        | %     |                                                |
| Drain-Source Voltage                        | V <sub>DSS</sub>  | 125       | Volts | 25°C                                           |
| Gate-to-Source Voltage                      | V <sub>GS</sub>   | -10, +2   | Volts | 25°C                                           |
| Storage Temperature                         | T <sub>STG</sub>  | -65, +150 | °C    |                                                |
| Operating Junction Temperature              | T <sub>J</sub>    | 225       | °C    |                                                |
| Maximum Forward Gate Current                | I <sub>GMAX</sub> | 80        | mA    | 25°C                                           |
| Maximum Drain Current <sup>1</sup>          | I <sub>DMAX</sub> | 24        | A     | 25°C                                           |
| Soldering Temperature <sup>2</sup>          | T <sub>S</sub>    | 245       | °C    |                                                |
| Screw Torque                                | τ                 | 40        | in-oz |                                                |
| Pulsed Thermal Resistance, Junction to Case | R <sub>θJC</sub>  | 0.22      | °C/W  | 100 μsec, 10%, 85°C, P <sub>DISS</sub> = 418 W |
| Pulsed Thermal Resistance, Junction to Case | R <sub>θJC</sub>  | 0.30      | °C/W  | 500 μsec, 10%, 85°C, P <sub>DISS</sub> = 418 W |
| Case Operating Temperature                  | T <sub>C</sub>    | -40, +125 | °C    |                                                |

Notes:

<sup>1</sup> Current limit for long term, reliable operation

<sup>2</sup> Refer to the Application Note on soldering at <http://www.cree.com/rf/tools-and-support/document-library>

## Electrical Characteristics

| Characteristics                                              | Symbol              | Min. | Typ. | Max. | Units           | Conditions                                       |
|--------------------------------------------------------------|---------------------|------|------|------|-----------------|--------------------------------------------------|
| <b>DC Characteristics<sup>1</sup> (T<sub>C</sub> = 25°C)</b> |                     |      |      |      |                 |                                                  |
| Gate Threshold Voltage                                       | V <sub>GS(th)</sub> | -3.8 | -3.0 | -2.3 | V <sub>DC</sub> | V <sub>DS</sub> = 10 V, I <sub>D</sub> = 83.6 mA |
| Gate Quiescent Voltage                                       | V <sub>GS(Q)</sub>  | –    | -2.7 | –    | V <sub>DC</sub> | V <sub>DS</sub> = 50 V, I <sub>D</sub> = 0.5 A   |
| Saturated Drain Current <sup>2</sup>                         | I <sub>DS</sub>     | 62.7 | 75.5 | –    | A               | V <sub>DS</sub> = 6.0 V, V <sub>GS</sub> = 2.0 V |
| Drain-Source Breakdown Voltage                               | V <sub>BR</sub>     | 150  | –    | –    | V <sub>DC</sub> | V <sub>GS</sub> = -8 V, I <sub>D</sub> = 83.6 mA |

Notes:

<sup>1</sup> Measured on wafer prior to packaging.

<sup>2</sup> Scaled from PCM data.

## Electrical Characteristics Continued...

| Characteristics                                                                                                                             | Symbol            | Min.  | Typ. | Max. | Units  | Conditions                                                                                                                                 |
|---------------------------------------------------------------------------------------------------------------------------------------------|-------------------|-------|------|------|--------|--------------------------------------------------------------------------------------------------------------------------------------------|
| <b>RF Characteristics<sup>3</sup> (<math>T_c = 25^\circ\text{C}</math>, <math>F_0 = 2.9 - 3.5\text{ GHz}</math> unless otherwise noted)</b> |                   |       |      |      |        |                                                                                                                                            |
| Output Power at 2.9 GHz                                                                                                                     | $P_{\text{OUT1}}$ | 445   | 500  | –    | W      | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$                                          |
| Output Power at 3.2 GHz                                                                                                                     | $P_{\text{OUT2}}$ | 475   | 535  | –    | W      | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$                                          |
| Output Power at 3.5 GHz                                                                                                                     | $P_{\text{OUT3}}$ | 410   | 480  | –    | W      | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$                                          |
| Gain at 2.9 GHz                                                                                                                             | $G_{\text{P1}}$   | 10.5  | 11   | –    | dB     | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$                                          |
| Gain at 3.2 GHz                                                                                                                             | $G_{\text{P2}}$   | 10.75 | 11.3 | –    | dB     | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$                                          |
| Gain at 3.5 GHz                                                                                                                             | $G_{\text{P3}}$   | 10.1  | 10.8 | –    | dB     | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$                                          |
| Drain Efficiency at 2.9 GHz                                                                                                                 | $D_{\text{E1}}$   | 60    | 70   | –    | %      | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$                                          |
| Drain Efficiency at 3.2 GHz                                                                                                                 | $D_{\text{E2}}$   | 60    | 70   | –    | %      | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$                                          |
| Drain Efficiency at 3.5 GHz                                                                                                                 | $D_{\text{E3}}$   | 54    | 64   | –    | %      | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$                                          |
| Small Signal Gain                                                                                                                           | $S_{21}$          | 10.5  | 12   | –    | dB     | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = -10\text{ dBm}$                                         |
| Input Return Loss                                                                                                                           | $S_{11}$          | –     | -8   | -3.0 | dB     | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = -10\text{ dBm}$                                         |
| Output Return Loss                                                                                                                          | $S_{22}$          | –     | -8   | -4.0 | dB     | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = -10\text{ dBm}$                                         |
| Amplitude Droop                                                                                                                             | $D$               | –     | -0.3 | –    | dB     | $V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$                                          |
| Output Stress Match                                                                                                                         | VSWR              | –     | 5:1  | –    | $\Psi$ | No damage at all phase angles,<br>$V_{\text{DD}} = 50\text{ V}$ , $I_{\text{DQ}} = 500\text{ mA}$ , $P_{\text{IN}} = 46\text{ dBm}$ Pulsed |

Notes:

<sup>3</sup> Measured in CGHV35400F-AMP. Pulse Width = 500  $\mu\text{s}$ , Duty Cycle = 10%.

## Electrostatic Discharge (ESD) Classifications

| Parameter           | Symbol | Class            | Test Methodology    |
|---------------------|--------|------------------|---------------------|
| Human Body Model    | HBM    | 1A (> 250 V)     | JEDEC JESD22 A114-D |
| Charge Device Model | CDM    | II (200 < 500 V) | JEDEC JESD22 C101-C |

## Typical Performance

Figure 1. - CGHV35400F Typical Sparameters  
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 0.5\text{ A}$

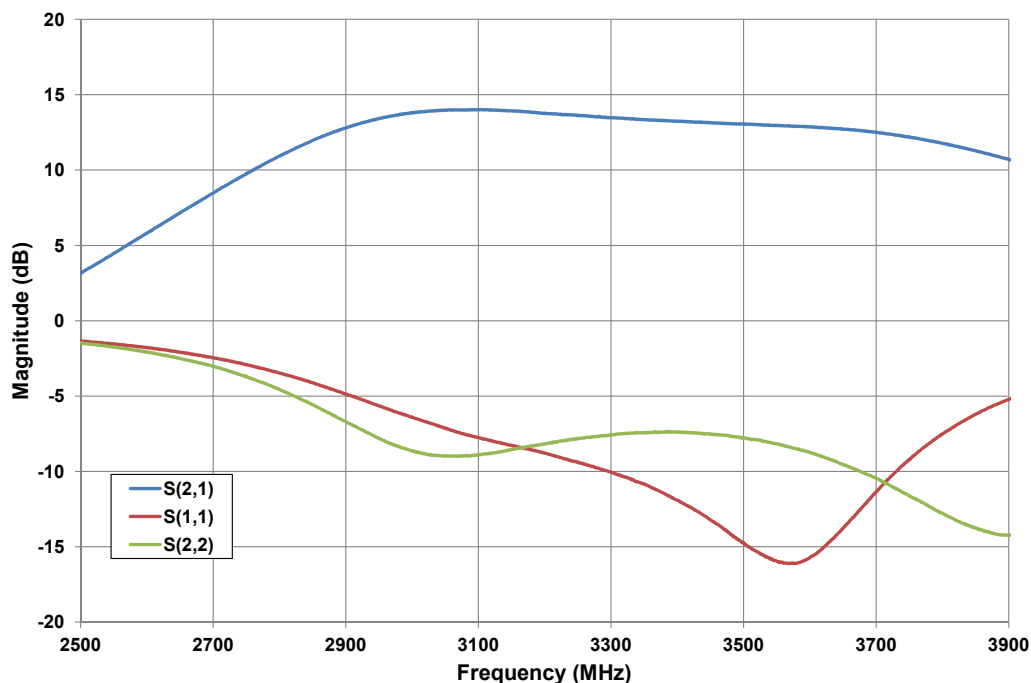
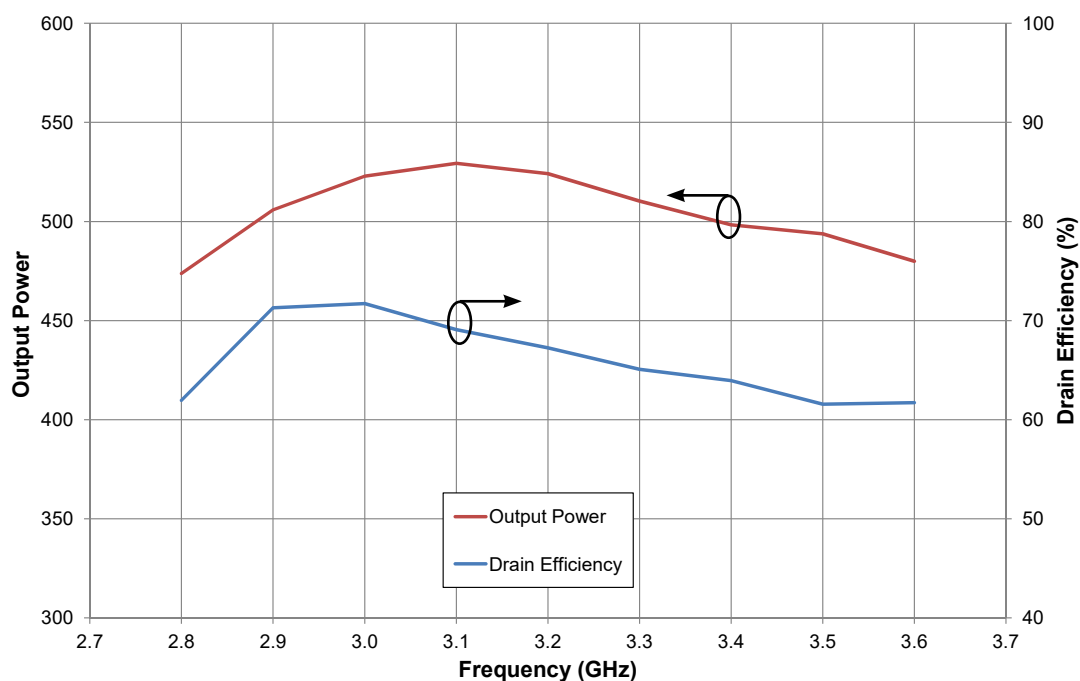
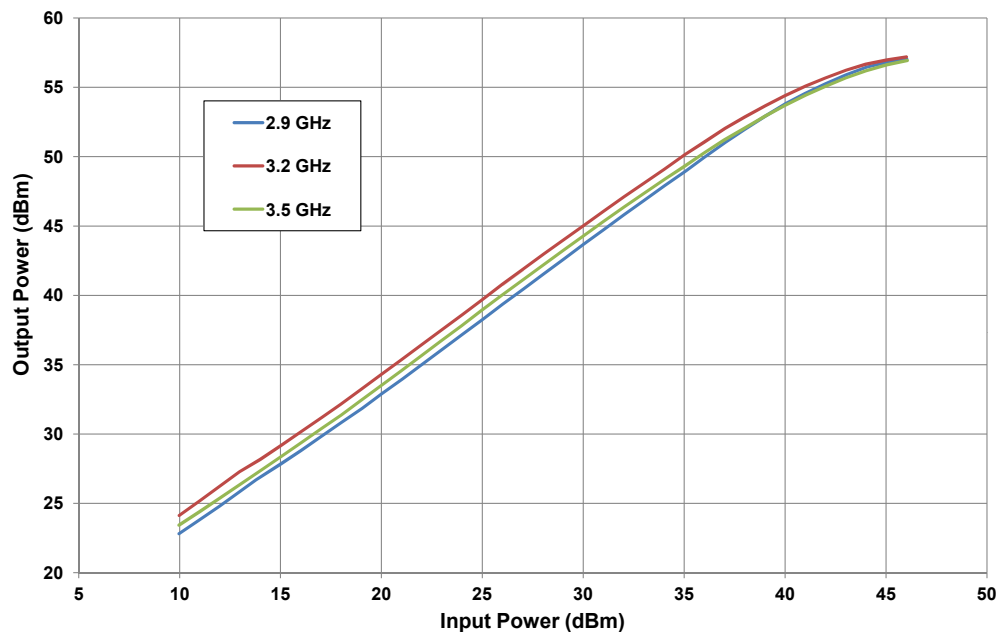


Figure 2. - CGHV35400F  $P_{OUT}$  and Drain Eff vs Frequency at  $T_{CASE} = 25^\circ\text{C}$   
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 0.5\text{ A}$ ,  $P_{IN} = 46\text{ dBm}$ , Pulse Width = 500 $\mu\text{s}$ , Duty Cycle = 10 %

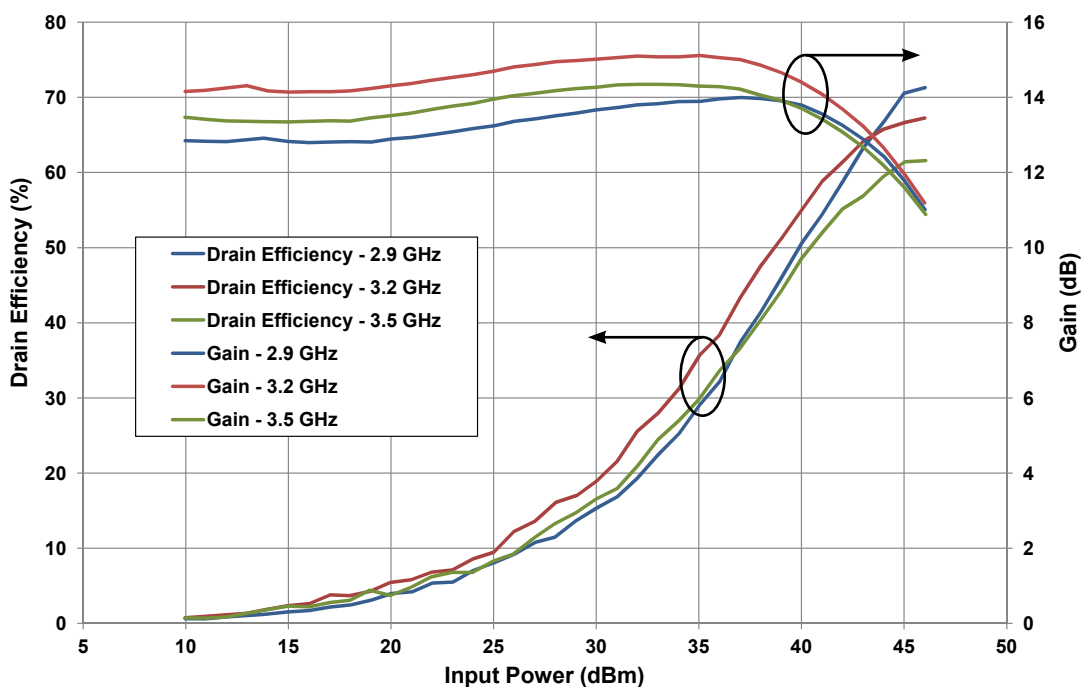


## Typical Performance

**Figure 3. - CGHV35400F Output Power vs Input Power**  
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 500\text{ mA}$ , Pulse Width = 500  $\mu\text{s}$ , Duty Cycle = 10 %,  $T_{case} = 25\text{ }^{\circ}\text{C}$



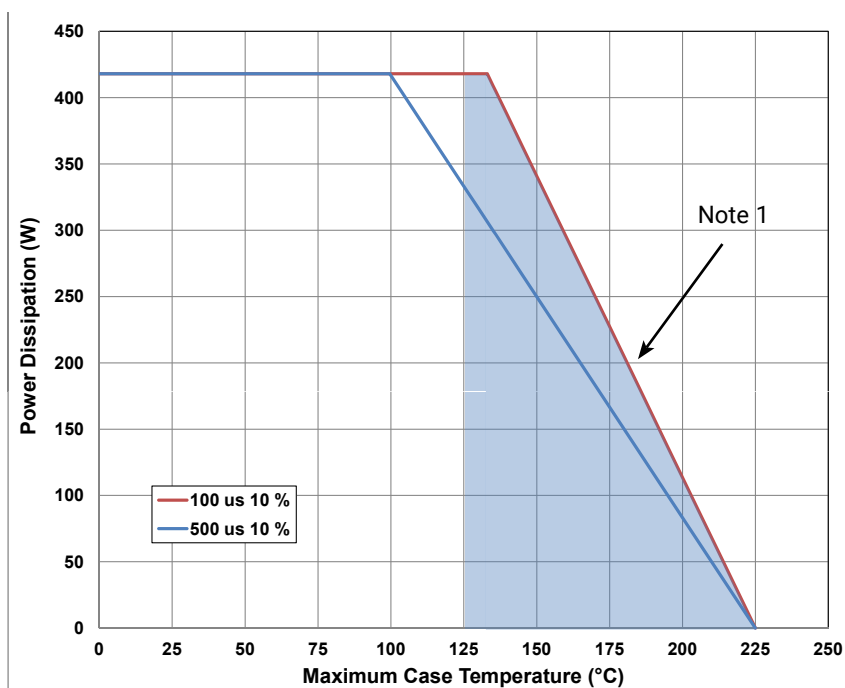
**Figure 4. - CGHV35400F Drain Efficiency & Gain vs Input Power**  
 $V_{DD} = 50\text{ V}$ ,  $I_{DQ} = 500\text{ mA}$ , Pulse Width = 500  $\mu\text{s}$ , Duty Cycle = 10 %,  $T_{case} = 25\text{ }^{\circ}\text{C}$



## CGHV35400F-AMP Application Circuit Bill of Materials

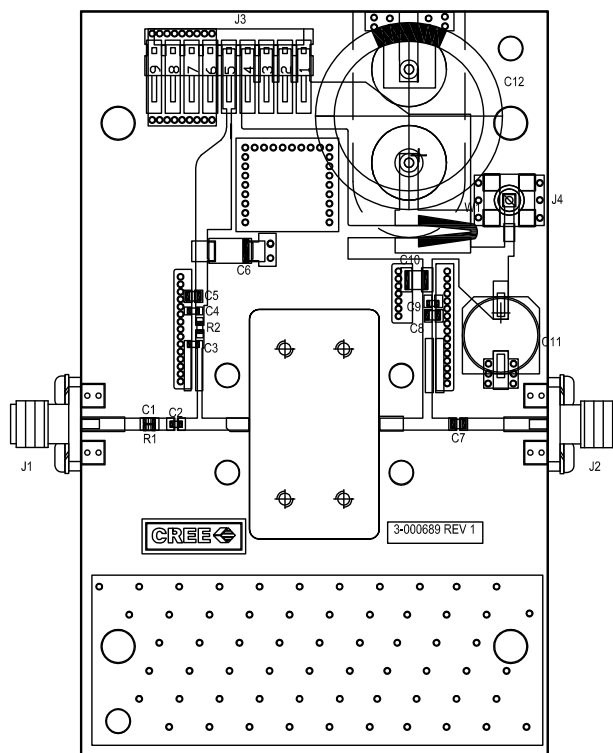
| Designator | Description                             | Qty |
|------------|-----------------------------------------|-----|
| R1         | RES, 511, OHM, +/- 1%, 1/16W, 0603      | 1   |
| R2         | RES, 5.1, OHM, +/- 1%, 1/16W, 0603      | 1   |
| C1         | CAP, 6.8pF, +/-0.25%, 250V, 0603        | 1   |
| C2, C7, C8 | CAP, 10.0pF, +/-1%, 250V, 0805          | 3   |
| C3         | CAP, 10.0pF, +/-5%, 250V, 0603          | 1   |
| C4, C9     | CAP, 470pF, 5%, 100V, 0603, X           | 2   |
| C5         | CAP, 33000 pF, 0805, 100V, X7R          | 1   |
| C6         | CAP, 10uF 16V TANTALUM                  | 1   |
| C10        | CAP, 1.0uF, 100V, 10%, X7R, 1210        | 1   |
| C11        | CAP, 33uF, 20%, G CASE                  | 1   |
| C12        | CAP, 3300uF, +/-20%, 100V, ELECTROLYTIC | 1   |
| J1,J2      | CONN, SMA, PANEL MOUNT JACK, FL         | 2   |
| J3         | HEADER, RT>PLZ, 0.1CEN LK 9POS          | 1   |
| J4         | CONNECTOR, SMB, Straight, JACK, SMD     | 1   |
| W1         | CABLE, 18 AWG, 4.2                      | 1   |
| -          | PCB, RO4350, 2.5 X 4.0 X 0.030          | 1   |
| Q1         | CGHV35400F                              | 1   |

## CGHV35400F Power Dissipation De-rating Curve

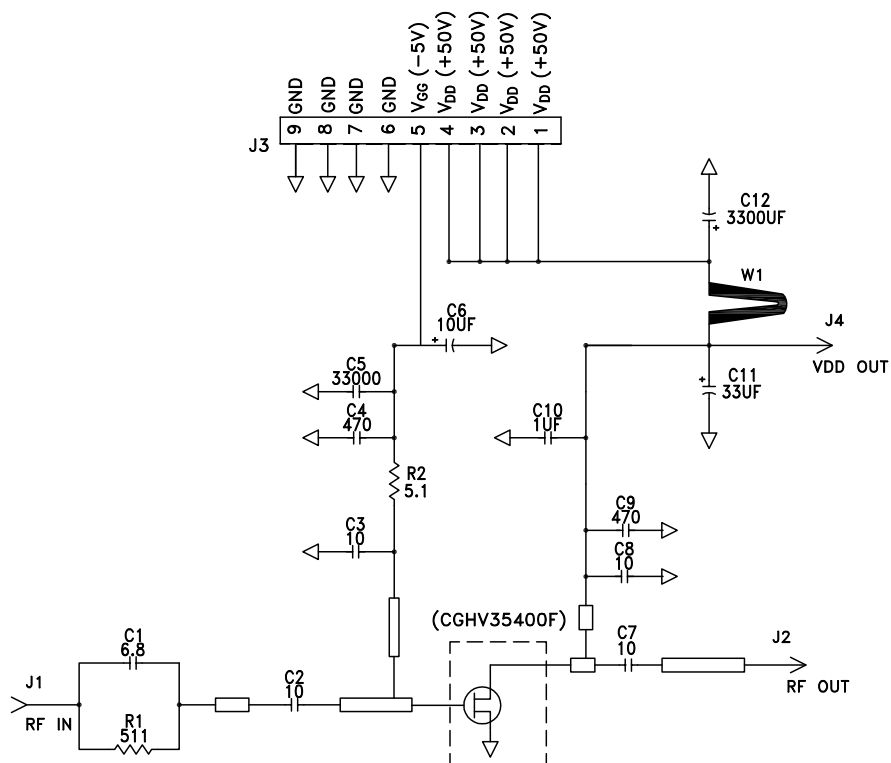


Note 1. Area exceeds Maximum Case Temperature (See Page 2).

## CGHV35400F-AMP Application Circuit Outline



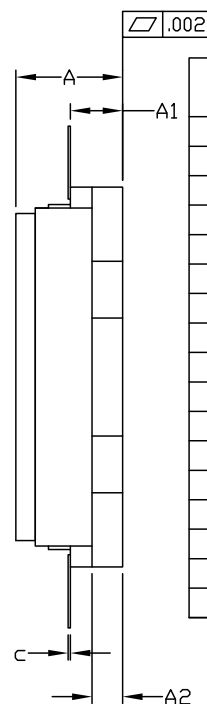
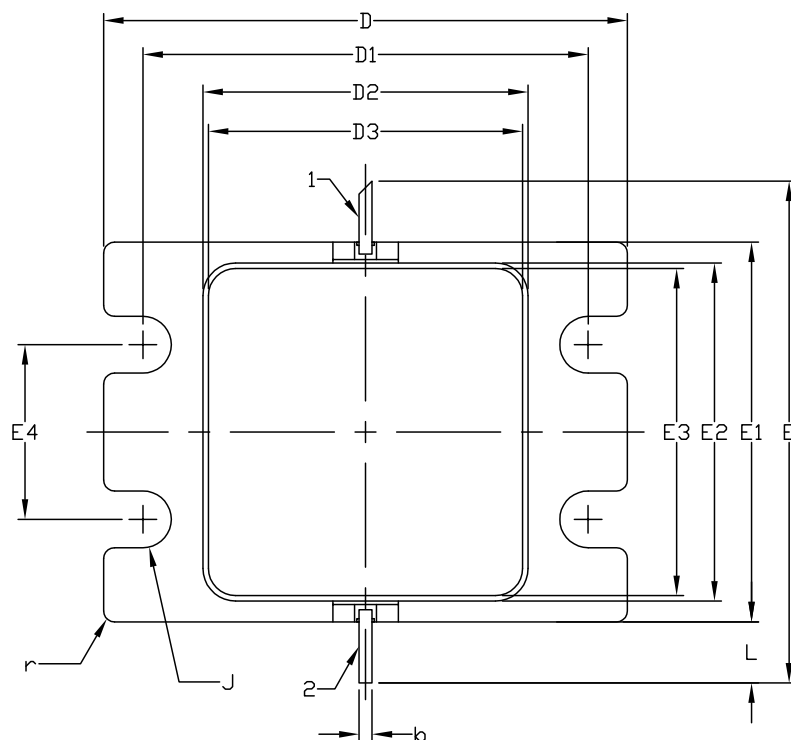
## CGHV35400F-AMP Application Circuit Schematic



## Product Dimensions CGHV35400F (Package Type – 440225)

NOTES: (UNLESS OTHERWISE SPECIFIED)

1. INTERPRET DRAWING IN ACCORDANCE WITH ANSI Y14.5M-2009
2. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF .020 BEYOND EDGE OF LID
3. LID MAY BE MISALIGNED TO THE BODY OF PACKAGE BY A MAXIMUM OF .008 IN ANY DIRECTION
4. ALL PLATED SURFACES ARE GOLD OVER NICKEL

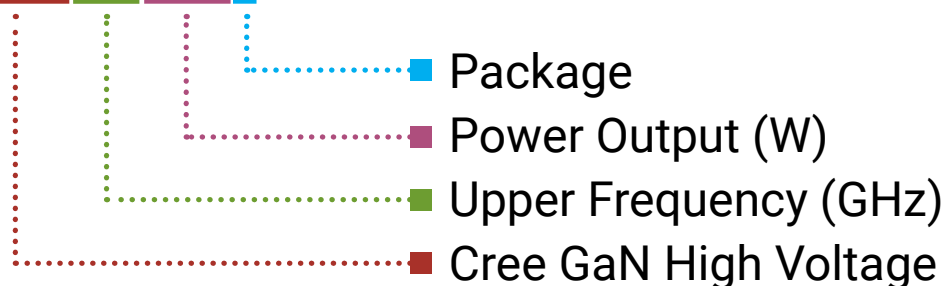


1. GATE  
2. DRAIN

| DIM | INCHES   |        | MILLIMETERS |       | NOTES |
|-----|----------|--------|-------------|-------|-------|
|     | MIN      | MAX    | MIN         | MAX   |       |
| A   | 0.188    | 0.198  | 4.78        | 5.03  |       |
| A1  | 0.088    | 0.100  | 2.24        | 2.54  | 2x    |
| A2  | 0.049    | 0.061  | 1.24        | 1.55  |       |
| b   | 0.022    | 0.026  | 0.56        | 0.66  | 2x    |
| c   | 0.002    | 0.006  | 0.05        | 0.15  |       |
| D   | 0.935    | 0.955  | 23.75       | 24.26 |       |
| D1  | 0.797    | 0.809  | 20.24       | 20.55 | 2x    |
| D2  | 0.581    | 0.593  | 14.76       | 15.06 |       |
| D3  | 0.563    | 0.571  | 14.30       | 14.50 |       |
| E   | 0.906    |        | 23.01       |       | REF   |
| E1  | 0.679    | 0.691  | 17.25       | 17.55 |       |
| E2  | 0.604    | 0.616  | 15.34       | 15.65 |       |
| E3  | 0.586    | 0.594  | 14.88       | 15.09 |       |
| E4  | 0.309    | 0.321  | 7.85        | 8.15  | 2x    |
| J   | Ø0.097   | Ø0.107 | Ø2.46       | Ø2.72 | 4x    |
| L   | 0.090    | 0.130  | 2.29        | 3.30  | 2x    |
| r   | 0.02 TYP |        | 0.51 TYP    |       | 12x   |

## Part Number System

**CGHV35400F**



| Parameter                    | Value  | Units |
|------------------------------|--------|-------|
| Upper Frequency <sup>1</sup> | 3.5    | GHz   |
| Power Output                 | 400    | W     |
| Package                      | Flange | -     |

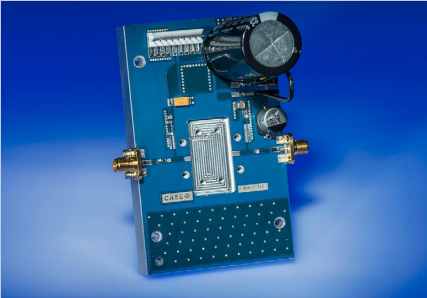
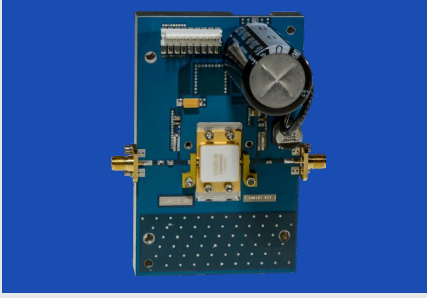
**Table 1.**

**Note<sup>1</sup>:** Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

| Character Code | Code Value                     |
|----------------|--------------------------------|
| A              | 0                              |
| B              | 1                              |
| C              | 2                              |
| D              | 3                              |
| E              | 4                              |
| F              | 5                              |
| G              | 6                              |
| H              | 7                              |
| J              | 8                              |
| K              | 9                              |
| Examples:      | 1A = 10.0 GHz<br>2H = 27.0 GHz |

**Table 2.**

## Product Ordering Information

| Order Number   | Description                        | Unit of Measure | Image                                                                                 |
|----------------|------------------------------------|-----------------|---------------------------------------------------------------------------------------|
| CGHV35400F     | GaN HEMT                           | Each            |    |
| CGHV35400F-TB  | Test board without GaN HEMT        | Each            |   |
| CGHV35400F-AMP | Test board with GaN HEMT installed | Each            |  |

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